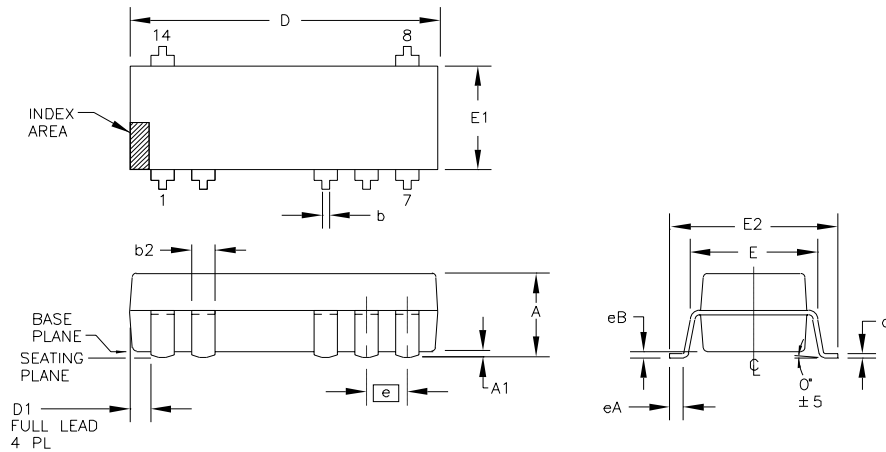


Package Number 010-2 - 14-Pin Plastic, Single-Wide DIP with Gull Wing Leads



DIM	INCHES		MILLIMETERS		NOTE
	MIN.	MAX.	MIN.	MAX.	
A	--	.210	--	5.33	
A1	.015	--	0.38	--	
b	.014	.022	0.36	0.56	
b2	.045	.070	1.14	1.78	5
c	.008	.014	0.20	0.36	
D	.735	.775	18.67	19.69	3
D1	.005	--	0.13	--	3
E	.300	.325	7.62	8.26	
E1	.240	.280	6.10	7.11	3
E2	.405	.420	10.30	10.70	
e	.100	BASIC	2.54	BASIC	
eA	.045	.057	1.15	1.45	
eB	.025	.043	0.65	1.10	
N	7		7		4

- NOTES:
1. ALL DIMENSIONS ARE IN INCHES.
 2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M-1982.
 3. D, D1, AND E1 DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 (0.25mm).
 4. N IS THE MAXIMUM OF TERMINAL POSITIONS.
 5. b2 MAXIMUM DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSIONS. DAMBAR PROTRUSIONS SHALL NOT EXCEED .010 (0.25mm).
 6. DISTANCE BETWEEN LEADS INCLUDING DAMBAR PROTRUSIONS TO BE .005 (0.13mm) MINIMUM.

7. A VISUAL INDEX FEATURE MUST BE LOCATED WITHIN THE CROSS-HATCHED AREA.
8. FOR AUTOMATIC INSERTION, ANY RAISED IRREGULARITY ON THE TOP SURFACE (STEP, MESA, ETC.) SHALL BE SYMMETRICAL ABOUT THE LATERAL AND LONGITUDINAL PACKAGE CENTERLINES.

PACKAGE NUMBER: ZZ010-2 REV.: B
 JEDEC NUMBER: NONE

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